# MBRS410ET3

# Surface Mount Schottky Power Rectifier

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "ORing" of multiple supply voltages and any other application where performance and size are critical.

#### Features

- Very Low V<sub>F</sub> Accompanied by Low I<sub>R</sub>
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Designed for Low Leakage
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard–Ring for Stress Protection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band on Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C Human Body Model = 3B

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (@ T <sub>L</sub> = 130°C)	Ι <sub>Ο</sub>	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	250	A
Operating Junction Temperature	TJ	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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## SCHOTTKY BARRIER RECTIFIERS 4.0 AMPERES, 10 VOLTS



SMC 2-LEAD CASE 403AC

#### MARKING DIAGRAM



B4E1 = Specific Device Code

= Assembly Location\*

= Year

A Y

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

\*The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
MBRS410ET3	SMC	2500/Tape & Reel	
MBRS410ET3G	SMC (Pb-Free)	2500/Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Semiconductor Components Industries, LLC, 2005 August, 2017 – Rev. 5

#### **THERMAL CHARACTERISTICS**

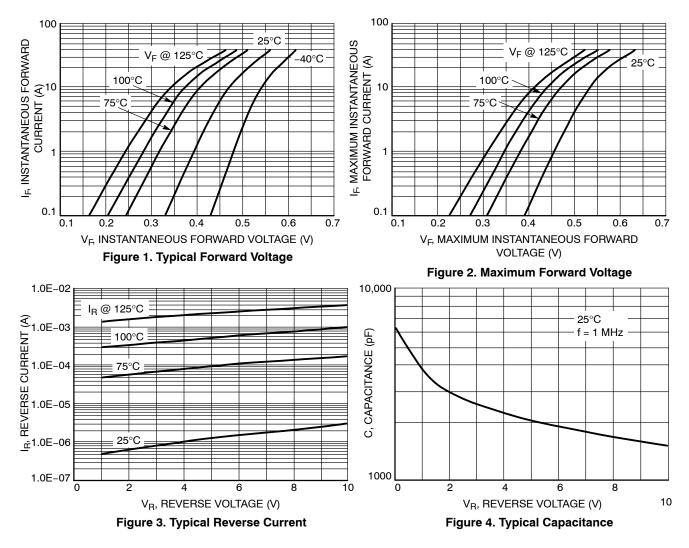
Characteristic	Symbol	<b>5 mm x 5 mm</b> (Note 2)	1 Inch x 1/2 inch	Unit
Thermal Resistance,				°C/W
Junction-to-Lead	$R_{ ext{ heta}JL}$	12	7.0	
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	109	59	
ELECTRICAL CHARACTERISTICS			•	
Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_{F} = 2.0 \text{ A})$		0.475	0.370	
$(I_{\rm F} = 4.0  {\rm A})$		0.500	0.395	
$(I_{F} = 8.0 \text{ A})$		0.525	0.430	
Maximum Instantaneous Reverse Current (Note 1)	I <sub>R</sub>	$T_J = 25^{\circ}C$	T <sub>J</sub> = 100°C	μΑ
(Rated dc Voltage, V <sub>R</sub> = 5.0 V)		50	2000	
(Rated dc Voltage, $V_R = 10 V$ )		150	4000	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

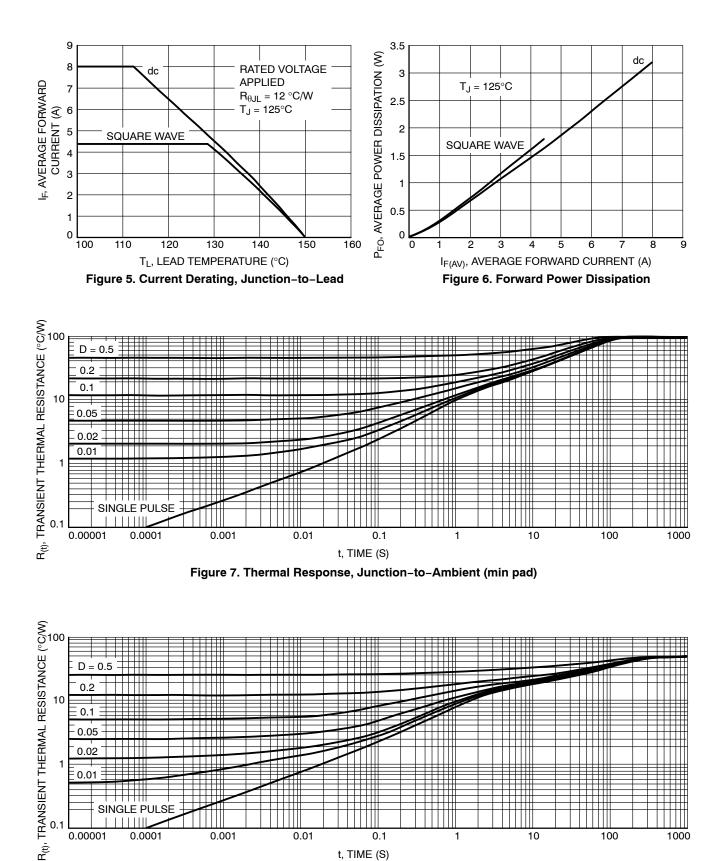
2. Mounted with Minimum Recommended Pad Size, PC Board FR4.

## **TYPICAL ELECTRICAL CHARACTERISTICS**



## MBRS410ET3

#### TYPICAL ELECTRICAL CHARACTERISTICS (continued)



t, TIME (S) Figure 8. Thermal Response, Junction-to-Ambient (1 inch pad)

0.1

0.01

1

ТП

10

100

1000

0.001

0.01

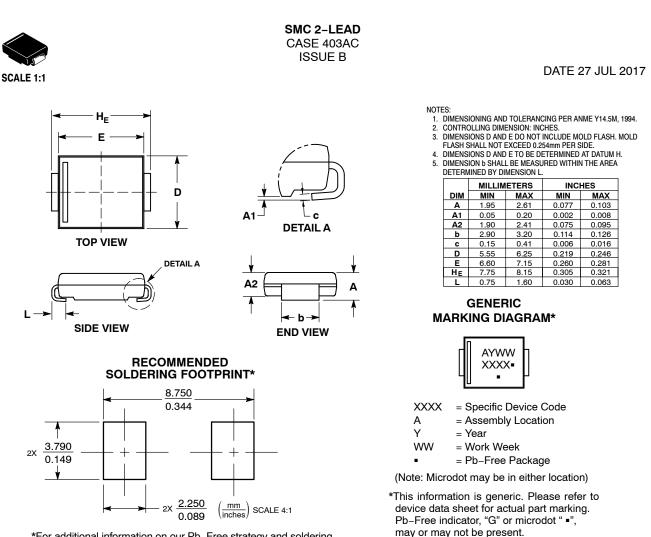
0.00001

+++++

SINGLE PULSE

0.0001





\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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